19-1049; Rev 1; 8/08

3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

General Description

The MAX2838 direct-conversion, zero-IF, RF transceiver is designed specifically for 3.3GHz to 3.9GHz wireless broadband systems. The MAX2838 completely integrates all circuitry required to implement the RF transceiver function, providing RF-to-baseband receive path, baseband-to-RF transmit path, VCO, frequency synthesizer, and baseband/control interface. The device includes a fast-settling sigma-delta RF synthesizer with smaller than 29Hz frequency steps. The MAX2838 supports 2Tx, 2Rx MIMO applications with a master device providing coherent LO to the slave device. The transceiver IC also integrates circuits for on-chip DC-offset cancellation, I/Q error, and carrier-leakage detection circuits. Only an RF bandpass filter (BPF), TCXO, RF switch, PA, and a small number of passive components are needed to form a complete wireless broadband RF radio solution.

The MAX2838 completely eliminates the need for an external SAW filter by implementing on-chip monolithic filters for both the receiver and transmitter. The baseband filters along with the Rx and Tx signal paths are optimized to meet the stringent noise figure and linearity specifications. The device supports up to 2048-FFT OFDM and implements programmable channel filters for 1.5MHz to 28MHz RF channel bandwidths. The transceiver requires only 2µs Tx-Rx switching time. The IC is available in a small 48-pin thin QFN package measuring only 6mm x 6mm x 0.8mm.

Applications

802.16-2004/802.16d Fixed WiMAX™

802.16e MIMO Mobile WiMAX

WiMAX Pico and Femto Basestations

NLOS Wireless Broadband Systems

WiMAX is a trademark of the WiMAX Forum.
SPI is a trademark of Motorola, Inc.

Ordering Information

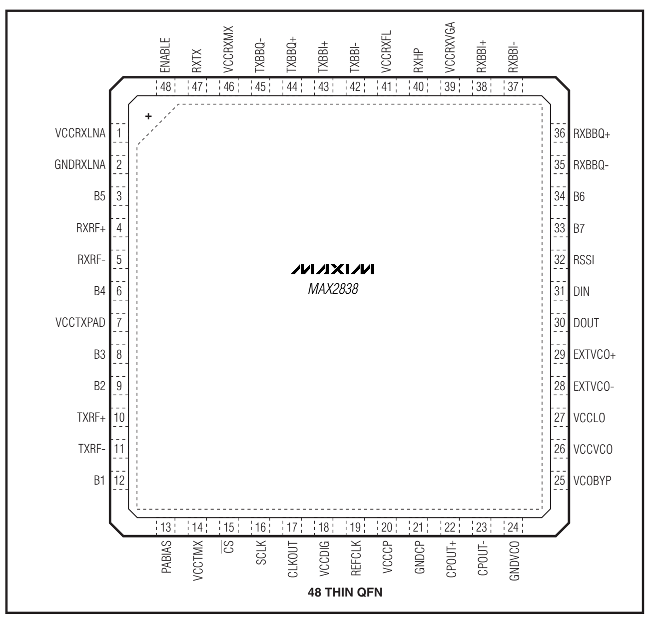
PART	TEMP RANGE	PIN-PACKAGE
MAX2838ETM+T	-40°C to +85°C	48 TQFN-EP*

**EP = Exposed paddle.*
+Denotes a lead-free package.
T = Tape and reel.

Features

- **3.3GHz to 3.9GHz Wide-Band Operation**
- **Master-Slave Modes with Coherent LO for MIMO**
- **Complete RF Transceiver, and PA Driver**
  - **0dBm Linear OFDM Transmit Power**
  - **-70dBr Tx Spectral Emission Mask**
  - **2.8dB Rx Noise Figure**
  - **Tx/Rx I/Q Error and LO Leakage Detection and Adjustment**
  - **Automatic Rx DC Offset Correction**
  - **Monolithic Low-Noise VCO with -39dBc Integrated Phase Noise**
  - **Programmable Rx I/Q Lowpass Channel Filters**
  - **Programmable Tx I/Q Lowpass Anti-Aliasing Filter**
  - **Sigma-Delta Fractional-N PLL with 29Hz Step Size**
  - **60dB Tx Gain Control Range with 1dB Step Size, Digitally Controlled**
  - **94dB Rx Gain Control Range with 2dB Step Size, Digitally Controlled**
  - **60dB Analog RSSI Instantaneous Dynamic Range**
  - **4-Wire SPI™ Digital Interface**
  - **I/Q Analog Baseband Interface**
  - **Digital Tx/Rx/Shutdown Mode Control**
  - **Low-Power CLOCKOUT Mode**
  - **On-Chip Digital Temperature Sensor Readout**
- **+2.7V to +3.6V Transceiver Supply**
- **Low-Power Shutdown Mode**
- **Small 48-Pin Thin QFN Package (6mm x 6mm x 0.8mm)**

Pin Configuration



ABSOLUTE MAXIMUM RATINGS

$V_{CC\_}$ Pins to GND..-0.3V to +3.6V
RF Inputs: RXRF+, RXRF-, EXTVCO+,
EXTVCO- to GND ....-0.3V to +3.6V
RF Outputs: TXRF+, TXRF-, EXTVCO+,
EXTVCO- to GND ....-0.3V to +3.6V
Analog Inputs: TXBBI+, TXBBI-, TXBBQ+,
TXBBQ-, REFCLK to GND ....-0.3V to +3.6V
Analog Outputs: RXBBI+, RXBBI-, RXBBQ+,
RXBBQ-, RSSI, VCOBYP, CPOUT+, CPOUT-,
PABIAS to GND ....-0.3V to +3.6V
Digital Inputs: ENABLE, RXTX, $\overline{CS}$, SCLK,
DIN, RXHP B1–B7 to GND ....-0.3V to +3.6V
Digital Outputs: DOUT, CLKOUT to GND ....-0.3V to +3.6V
Short-Circuit Duration
Analog Outputs: RXBBI+, RXBBI-, RXBBQ+,
RSSI, VCOBYP,RXBBQ-, CPOUT+, CPOUT-,
PABIAS, TXRF-, TXRF+ 10s
Digital Outputs: DOUT, CLKOUT 10s
RF Input Power: RXRF+, RXRF- ....+15dBm
RF Output Differential Load VSWR: TXRF+, TXRF- 6:1
Continuous Power Dissipation (T_A = +70°C)
48-Pin Thin QFN (derate 37mW/°C above +70°C) ...... > 2.96W
Operating Temperature Range ....-40°C to +85°C
Junction Temperature ....+150°C
Storage Temperature Range ....-65°C to +160°C
Lead Temperature (soldering, 10s) ....+300°C

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

CAUTION! ESD SENSITIVE DEVICE

DC ELECTRICAL CHARACTERISTICS

(MAX2838 Evaluation Kit, $V_{CC\_}$ = 2.7V to 3.6V, T_A = -40°C to +85°C, ENABLE and RXTX set according to operating mode, $\overline{CS}$ = high, SCLK = DIN = low, transmitter and receiver in maximum gain, no input signal at RF inputs, all RF inputs and outputs terminated into 50Ω, receiver baseband outputs are open. 90mV_{RMS} differential I and Q signals (1MHz) applied to I and Q baseband inputs of transmitter in transmit mode, all registers set to recommended settings and corresponding test mode, unless otherwise noted. Typical values are at V_{CC} = 2.8V, f_{LO} = 3.6GHz, and T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETERS	CONDITIONS		MIN	TYP	MAX	UNITS
Supply Voltage	$V_{CC\_}$		2.7	2.8	3.6	V
Supply Current	Shutdown mode	T_A = +25°C		12		µA
	Standby mode, see Tables 1 and 2	Single configuration		35	52	mA
		MIMO master configuration		44		
		MIMO slave configuration		11		
	Rx mode, see Tables 1 and 2	Single configuration		103	133	
		MIMO master configuration		112		
		MIMO slave configuration		80		
	Tx mode, see Tables 1 and 2	Single configuration		152	186	
		MIMO master configuration		160		
		MIMO slave configuration		128		
	Rx calibration mode, see Tables 1 and 2	Single configuration		142	182	
		MIMO master configuration		151		
		MIMO slave configuration		119		
	Tx calibration mode, see Tables 1 and 2	Single configuration		111	145	
		MIMO master configuration		120		
		MIMO slave configuration		88		
Rx I/Q Output Common-Mode Voltage	D9:D8 = 00 in A4:A0 = 00100		0.8	1.0	1.2	V
	D9:D8 = 01 in A4:A0 = 00100			1.1		
	D9:D8 = 10 in A4:A0 = 00100			1.2		
	D9:D8 = 11 in A4:A0 = 00100			1.35		

DC ELECTRICAL CHARACTERISTICS (continued)

(MAX2838 Evaluation Kit, $V_{CC\_}$ = 2.7V to 3.6V, T_A = -40°C to +85°C, ENABLE and RXTX set according to operating mode, $\overline{CS}$ = high, SCLK = DIN = low, transmitter and receiver in maximum gain, no input signal at RF inputs, all RF inputs and outputs terminated into 50Ω, receiver baseband outputs are open. $90mV_{RMS}$ differential I and Q signals (1MHz) applied to I and Q baseband inputs of transmitter in transmit mode, all registers set to recommended settings and corresponding test mode, unless otherwise noted. Typical values are at V_{CC} = 2.8V, f_{LO} = 3.6GHz, and T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETERS	CONDITIONS	MIN	TYP	MAX	UNITS
Tx Baseband Input Common-Mode Voltage Operating Range	DC-coupled	0.5		1.2	V
Tx Baseband Input Bias Current	Source current		8	20	µA
LOGIC INPUTS: ENABLE, RXTX, SCLK, DIN, $\overline{CS}$, B1:B7, RXHP					
Digital Input Voltage High, V_{IH}		V_{CC} - 0.4			V
Digital Input Voltage Low, V_{IL}				0.4	V
Digital Input Current High, I_{IH}		-1		+1	µA
Digital Input Current Low, I_{IL}		-1		+1	µA
LOGIC OUTPUTS: DOUT					
Digital Output Voltage High, V_{OH}	Sourcing 100µA	V_{CC} - 0.4			V
Digital Output Voltage Low, V_{OL}	Sinking 100µA			0.4	V

AC ELECTRICAL CHARACTERISTICS—Rx MODE

(MAX2838 Evaluation Kit, $V_{CC\_}$ = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{RF} = 3.601GHz, receiver baseband I/Q outputs at $90mV_{RMS}$, f_{REF} = 40MHz, $\overline{CS}$ = ENABLE = RXTX = high, SCLK = DIN = low, channel bandwidth BW = 7MHz, with power matching for the RF inputs using the typical applications and registers set to default settings and corresponding test mode, unless otherwise noted. Unmodulated single-tone RF input signal is used with specifications that normally apply over the entire operating conditions, unless otherwise indicated. Rx I/Q differential output load impedance = 10kΩ ll 8pF.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
RECEIVER SECTION: LNA RF INPUT TO BASEBAND I/Q OUTPUTS					
RF Input Frequency Range		3.3		3.9	GHz
Peak-to-Peak Gain Variation over RF Input Frequency Range	Tested at band edges and band center		1.8		dB
RF Input Return Loss	All LNA settings		10		dB
Total Voltage Gain	T_A = -40°C to +85°C, Maximum gain, B7:B1 = 0000000	88	98		dB
	T_A = -40°C to +85°C, Minimum gain, B7:B1 = 1111111		5	10	
RF Gain Steps	From max RF gain to max RF Gain - 8dB		8		dB
	From max RF gain to max RF gain - 16dB		16		
	From max RF gain to max RF gain - 32dB		32		
Gain Change Settling Time	Any RF or baseband gain change; gain settling to within ±1dB of steady state; RXHP = 1		200		ns
	Any RF or baseband gain change; gain settling to within ±0.1dB of steady state; RXHP = 1		500		
Baseband Gain Range	From maximum baseband gain (B5:B1 = 00000) to minimum baseband gain (B5:B1 = 11111)		62		dB
Baseband Gain Minimum Step Size			2		dB

3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

AC ELECTRICAL CHARACTERISTICS—Rx MODE (continued)

(MAX2838 Evaluation Kit, $V_{CC\_}$ = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{RF} = 3.601GHz, receiver baseband I/Q outputs at 90mV_{RMS}, f_{REF} = 40MHz, $\overline{CS}$ = ENABLE = RXTX = high, SCLK = DIN = low, channel bandwidth BW = 7MHz, with power matching for the RF inputs using the typical applications and registers set to default settings and corresponding test mode, unless otherwise noted. Unmodulated single-tone RF input signal is used with specifications that normally apply over the entire operating conditions, unless otherwise indicated. Rx I/Q differential output load impedance = 10kΩ ll 8pF.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
DSB Noise Figure	Voltage gain ≥ 65dB with max RF gain (B7:B6 = 00)		2.9		dB
	Voltage gain = 50dB with max RF gain - 8dB (B7:B6 = 01)		7.9		
	Voltage gain = 45dB with max RF gain - 16dB (B7:B6 = 10)		13.7		
	Voltage gain = 15dB with max RF gain - 32dB (B7:B6 = 11)		31.4		
In-Band Input P-1dB	Max RF gain (B7:B6 = 00)		-35		dBm
	Max RF gain - 8dB (B7:B6 = 01)		-27		
	Max RF gain - 16dB (B7:B6 = 10)		-19		
	Max RF gain - 32dB (B7:B6 = 11)		-3		
Maximum Output Signal Level	Over passband frequency range; at any gain setting; 1dB compression point, differential output		2.5		V_{P-P}
Out-of-Band Input IP3 (Note 2)	Max RF gain (B7:B6 = 00), AGC set for -65dBm wanted signal		-10		dBm
	Max RF gain - 8dB (B7:B6 = 01), AGC set for -55dBm wanted signal		-5		
	Max RF gain - 16dB (B7:B6 = 10), AGC set for -40dBm wanted signal		-4		
	Max RF gain - 32dB (B7:B6 = 11), AGC set for -30dBm wanted signal		+23		
I/Q Phase Error	1MHz baseband output; 1 σ variation, T_A = +25°C		0.15		Degrees
I/Q Gain Imbalance	1MHz baseband output; 1 σ variation, T_A = +25°C		0.05		dB
I/Q Output DC Droop	After completion of default power-on on-chip DC cancellation, 1 σ variation		±1		V/s
I/Q Static DC Offset	No RF input signal; B7:B1 = 0000000, after completion of default power-on on-chip DC cancellation, 1 σ variation		±1.0		mV
Loopback Gain (for Receiver I/Q Calibration)	Transmitter I/Q input to receiver I/Q output; transmitter B6:B1 = 000011, receiver B5:B1 = 10011 programmed through SPI	-7.0	-2	+2.5	dB
RECEIVER BASEBAND FILTERS					
Baseband Highpass Filter Corner Frequency	Corner frequency 1		600		kHz
	Corner frequency 2		100		
	Corner frequency 3		30		
	Corner frequency 4		1		
	Corner frequency 5		0.1		

AC ELECTRICAL CHARACTERISTICS—Rx MODE (continued)

(MAX2838 Evaluation Kit, $V_{CC\_}$ = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{RF} = 3.601GHz, receiver baseband I/Q outputs at $90mV_{RMS}$, f_{REF} = 40MHz, $\overline{CS}$ = ENABLE = RXTX = high, SCLK = DIN = low, channel bandwidth BW = 7MHz, with power matching for the RF inputs using the typical applications and registers set to default settings and corresponding test mode, unless otherwise noted. Unmodulated single-tone RF input signal is used with specifications that normally apply over the entire operating conditions, unless otherwise indicated. Rx I/Q differential output load impedance = 10kΩ ll 8pF.) (Note 1)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
RF Channel BW Supported by Baseband Filter	A4:A0 = 00010 serial bits D7:D4 = 0000			1.5		MHz
	A4:A0 = 00010 serial bits D7:D4 = 0001			1.75		
	A4:A0 = 00010 serial bits D7:D4 = 0010			3.5		
	A4:A0 = 00010 serial bits D7:D4 = 0011			5.0		
	A4:A0 = 00010 serial bits D7:D4 = 0100			5.5		
	A4:A0 = 00010 serial bits D7:D4 = 0101			6.0		
	A4:A0 = 00010 serial bits D7:D4 = 0110			7.0		
	A4:A0 = 00010 serial bits D7:D4 = 0111			8.0		
	A4:A0 = 00010 serial bits D7:D4 = 1000			9.0		
	A4:A0 = 00010 serial bits D7:D4 = 1001			10.0		
	A4:A0 = 00010 serial bits D7:D4 = 1010			12.0		
	A4:A0 = 00010 serial bits D7:D4 = 1011			14.0		
	A4:A0 = 00010 serial bits D7:D4 = 1100			15.0		
	A4:A0 = 00010 serial bits D7:D4 = 1101			20.0		
	A4:A0 = 00010 serial bits D7:D4 = 1110			24.0		
	A4:A0 = 00010 serial bits D7:D4 = 1111			28.0		
Baseband Gain Ripple	0 to 3.2MHz for BW = 7MHz			1		dB_{P-P}
Baseband Group Delay Ripple	0 to 3.2MHz for BW = 7MHz			65		ns_{P-P}
Baseband Filter Rejection for 7MHz RF Channel BW	At 4.67MHz			7		dB
	At > 10.5MHz			53		
	At > 14MHz			75		
	At > 29.4MHz			75		
RSSI						
RSSI Minimum Output Voltage	R_{LOAD} ≥ 10kΩ			0.65		V
RSSI Maximum Output Voltage	R_{LOAD} ≥ 10kΩ			2.4		V
RSSI Slope				30		mV/dB
RSSI Output Settling Time	To within 3dB of steady state	+32dB signal step		200		ns
		-32dB signal step		800		

3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

AC ELECTRICAL CHARACTERISTICS—Tx MODE

(MAX2838 Evaluation Kit, $V_{CC\_}$ = 2.8V, T_A = +25°C, f_{RF} = 3.601GHz , f_{LO} = 3.6GHz. f_{REF} = 40MHz, ENABLE = $\overline{CS}$ = high, and RXTX = SCLK = DIN = low, with power matching for the differential RF pins using the *Typical Operating Circuit*. Lowpass filter is set to 7MHz RF channel BW, $90mV_{RMS}$ sine and cosine signal (or $90mV_{RMS}$ 64QAM 1024-FFT OFDMA FUSC I/Q signals wherever OFDM is mentioned) applied to baseband I/Q inputs of transmitter (differential DC-coupled). Registers set to recommended settings and corresponding test mode, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
TRANSMIT SECTION: Tx BASEBAND I/Q INPUTS TO RF OUTPUTS					
RF Output Frequency Range		3.3		3.9	GHz
Peak-to-Peak Gain Variation over RF Band			2.6		dB
Total Voltage Gain	Maximum gain; at unbalanced 50Ω matched output		8		dB
Maximum Output Power over Frequency	OFDM signal conforming to spectral emission mask and -36dB EVM after I/Q imbalance calibration by modem (Note 3)		0		dBm
RF Output Return Loss	All gain settings		7		dB
RF Gain Control Range			60		dB
RF Gain Control Binary Weights	B1		1		dB
	B2		2		
	B3		4		
	B4		8		
	B5		16		
	B6		32		
Unwanted Sideband Suppression	Without calibration by modem, and excludes modem I/Q imbalance; P_{OUT} = 0dBm		-40		dBc
Carrier Leakage	Relative to 0dBm output power; without calibration by modem		-40		dBc
Tx I/Q Input Impedance (R ll C)	Minimum differential resistance		60		kΩ
	Maximum differential capacitance		0.5		pF
Baseband Frequency Response for 7MHz RF Channel BW	0 to 4.67MHz		-8		dB
	At > 13.23MHz		-45		
Baseband Group Delay Ripple	0 to 4.9MHz (BW = 7MHz)		15		ns_{P-P}

AC ELECTRICAL CHARACTERISTICS—FREQUENCY SYNTHESIS

(MAX2838 Evaluation Kit, V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, SCLK = DIN = low, PLL loop bandwidth = 180kHz, charge-pump comparison frequency = 40MHz, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
FREQUENCY SYNTHESIZER					
RF Channel Center Frequency		3.3		3.9	GHz
Channel Center Frequency Programming Minimum Step Size			29		Hz
Charge-Pump Comparison Frequency		11	40		MHz
Reference Frequency Range		11	40	80	MHz
Reference Frequency Input Levels	AC-coupled to REFCLK pin	800			mV_{P-P}

AC ELECTRICAL CHARACTERISTICS—FREQUENCY SYNTHESIS (continued)

(MAX2838 Evaluation Kit, V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, SCLK = DIN = low, PLL loop bandwidth = 180kHz, charge-pump comparison frequency = 40MHz, T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Programmable Reference Divider Values	A4:A0 = 10100, D2:D1 = 00			1		
	A4:A0 = 10100, D2:D1 = 01			2		
Closed-Loop Integrated Phase Noise	Loop BW = 180kHz, integrate phase noise from 200Hz to 5MHz			-39		dBc
Charge-Pump Output Current	On each differential side			0.8		mA
Close-In Spur Level	f_{OFFSET} = 0 to 1.8MHz			-45		dBc
	f_{OFFSET} = 1.8MHz to 7MHz			-70		
	f_{OFFSET} > 7MHz			-80		
Reference Spur Level	f_{OFFSET} ≥ 40MHz			-73		dBc
Turnaround LO Frequency Error	Relative to steady state; measured 35µs after Tx-Rx or Rx-Tx switching instant, and 4µs after any receiver gain changes			±50		Hz
Temperature Range over which VCO Maintains Lock	Relative to the initial ambient temperature T_A, as long as the final temperature is within operating temperature range			T_A ± 40		°C
CLKOUT Frequency Divider Values	A4:A0 = 10100, D6:D5 = 01 (Note 4)			2		
CLKOUT Output Swing	R = 10kΩ, C = 10pF	Low drive		1.6		V_{P-P}
		High drive		2.4		
External VCO Input Power	MIMO slave mode only			-10		dBm
External VCO Output Power	MIMO master mode only			-8		dBm

AC ELECTRICAL CHARACTERISTICS—MISCELLANEOUS BLOCKS

(MAX2838 Evaluation Kit, V_{CC} = 2.8V, f_{REF} = 40MHz, $\overline{CS}$ = high, SCLK = DIN = low, and T_A = +25°C, unless otherwise noted) (Note 1)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
PA BIAS DAC: CURRENT MODE						
Numbers of bits				6		
Minimum Output Sink Current	D5:D0 = 000000 in A4:A0 = 11100			0		µA
Maximum Output Sink Current	D5:D0 = 111111 in A4:A0 = 11100			310		µA
Compliance Voltage Range			0.8			V
Turn-On Time	Excludes programmable delay of 0 to 7µs in steps of 0.5µs			200		ns
DNL				1		LSB
PA BIAS DAC: VOLTAGE MODE						
Output High Level	10mA source current			V_{CC} - 0.2		V
Output Low Level	10mA sink current			0.1		V
Turn-On Time	Excludes programmable delay of 0 to 7µs in steps of 0.5µs			200		ns
ON-CHIP TEMPERATURE SENSOR						
Digital Output Code	Read-out at DOUT pin through SPI A4:A0 = 00111, D4:D0	T_A = +25°C		01111		
		T_A = +85°C		11001		
		T_A = -40°C		00100		
Temperature Step Size				5		°C

AC ELECTRICAL CHARACTERISTICS—TIMING

(MAX2838 Evaluation Kit, V_{CC} = 2.8V, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, SCLK = DIN = low, PLL loop bandwidth = 180kHz, and T_A = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SYSTEM TIMING						
Channel Switching Time	Frequency error settles to ±50Hz	Automatic VCO sub-band selection		2		ms
		Manual VCO sub-band selection		56		µs
Turnaround Time		Measured from Tx or Rx enable rising edge, signal settling to within 0.5dB of steady state: Rx to Tx		2		µs
		Measured from Tx or Rx enable rising edge, signal settling to within 0.5dB of steady state: Tx to Rx		2		µs
Tx Turn-On Time (from Standby Mode)		Measured from Tx enable rising edge, signal settling to within 0.5dB of steady state		2		µs
Tx Turn-Off Time (to Standby Mode)		From Tx-enable falling edge		0.1		µs
Rx Turn-On Time (from Standby Mode)		Measured from Rx enable rising edge, signal settling to within 0.5dB of steady state		2		µs
Rx Turn-Off Time (to Standby Mode)		From Rx-enable falling edge		0.1		µs
4-WIRE SERIAL INTERFACE TIMING (See Figure 1)						
SCLK Rising Edge to $\overline{CS}$ Falling Edge Wait Time	t_{CSO}			6		ns
Falling Edge of $\overline{CS}$ to Rising Edge of First SCLK Time	t_{CSS}			6		ns
DIN to SCLK Setup Time	t_{DS}			6		ns
DIN to SCLK Hold Time	t_{DH}			6		ns
SCLK Pulse-Width High	t_{CH}			6		ns
SCLK Pulse-Width Low	t_{CL}			6		ns
Last Rising Edge of SCLK to Rising Edge of $\overline{CS}$ or Clock to Load Enable Setup Time	t_{CSH}			6		ns
$\overline{CS}$ High Pulse Width	t_{CSW}			20		ns
Time Between Rising Edge of $\overline{CS}$ and the Next Rising Edge of SCLK	t_{CS1}			6		ns
Clock Frequency	f_{CLK}				45	MHz
Rise Time	t_R			f_{CLK} / 10		ns
Fall Time	t_F			f_{CLK} / 10		ns
SCLK Falling Edge to Valid DOUT	t_D			12.5		ns

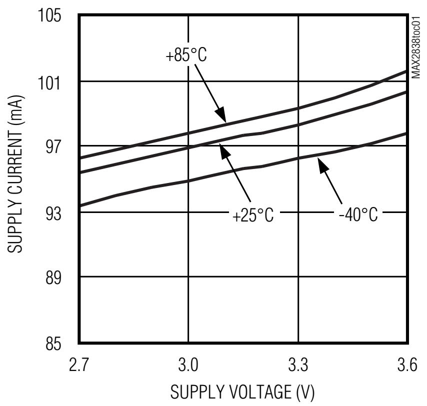
Note 1: Min and max limits are guaranteed by test above T_A = +25°C and are guaranteed by design and characterization at T_A = -40°C. The power-on register settings are not guaranteed. Recommended register setting must be loaded after V_{CC} is supplied.
Note 2: Two tones at +20MHz and +39MHz offset with -35dBm/tone. Measure IM3 at 1MHz.
Note 3: Gain adjusted over max gain and max gain - 3dB.
Note 4: V_{CC} rise time (0V to 2.7V) must be less than 1ms.

Typical Operating Characteristics

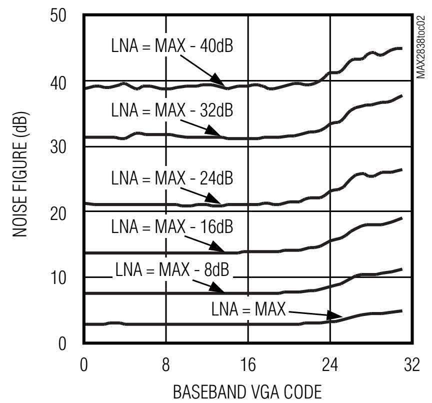
(V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, RXHP = SCLK = DIN = low, RF BW = 7MHz, using the MAX2838 Evaluation Kit.)

RECEIVER

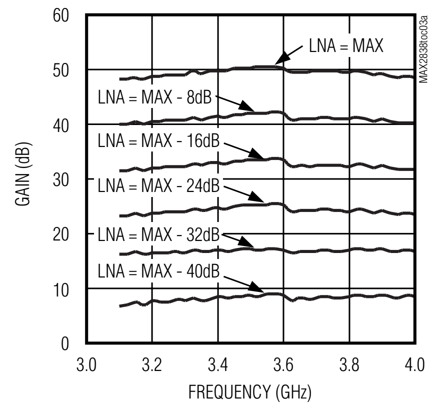
Rx SUPPLY CURRENT vs. SUPPLY VOLTAGE



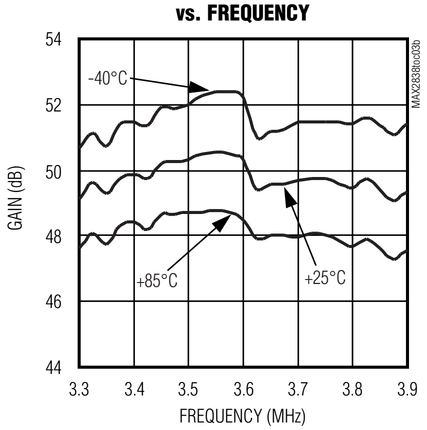
NOISE FIGURE vs. BASEBAND GAIN SETTING



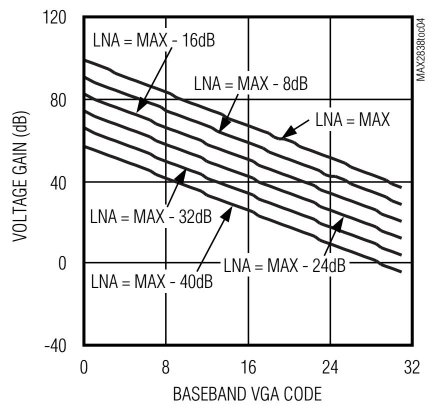
Rx VOLTAGE GAIN vs. FREQUENCY



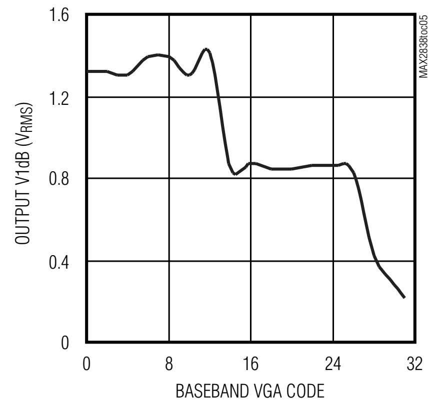
Rx VOLTAGE GAIN (MAXIMUM LNA GAIN) vs. FREQUENCY



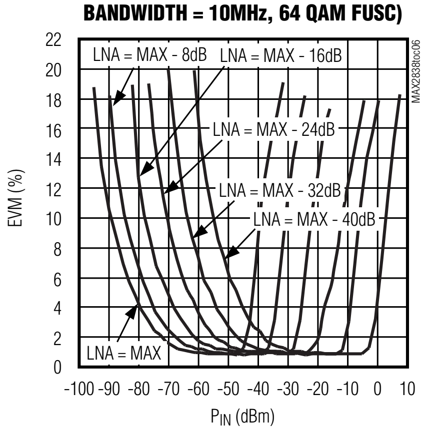
Rx VOLTAGE GAIN vs. BASEBAND GAIN SETTING



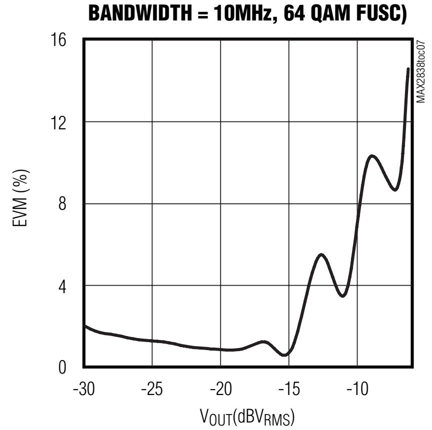
Rx OUTPUT V1dB vs. GAIN SETTING



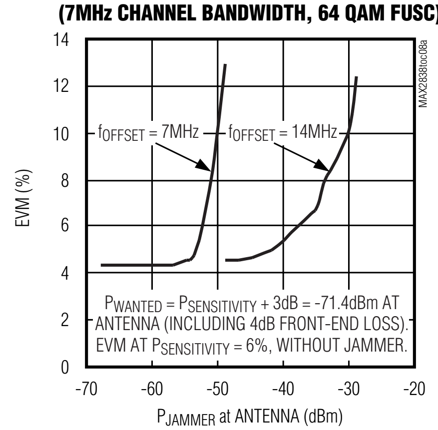
Rx EVM vs. P_{IN} (CHANNEL BANDWIDTH = 10MHz, 64 QAM FUSC)



Rx EVM vs. V_{OUT} (CHANNEL BANDWIDTH = 10MHz, 64 QAM FUSC)



WiMAX EVM vs. OFDM JAMMER (7MHz CHANNEL BANDWIDTH, 64 QAM FUSC)

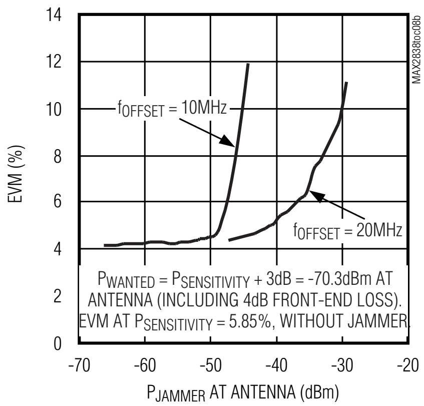


3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

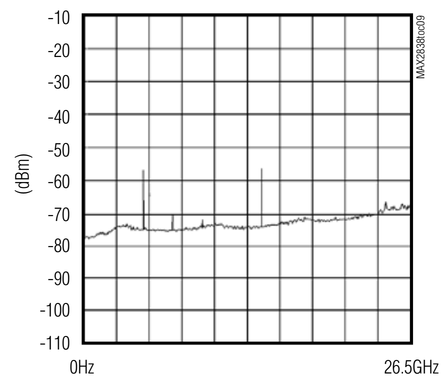
Typical Operating Characteristics (continued)

(V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, RXHP = SCLK = DIN = low, RF BW = 7MHz, using the MAX2838 Evaluation Kit.)

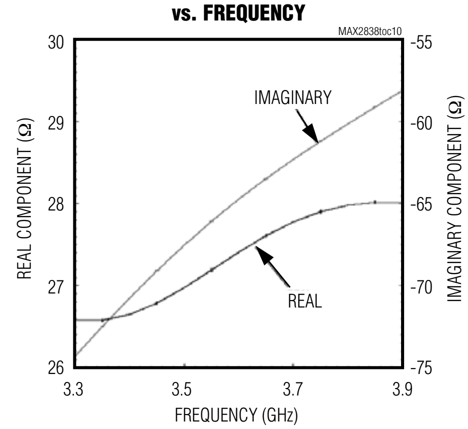
WiMAX EVM vs. OFDM JAMMER (10MHz CHANNEL BANDWIDTH, 64 QAM FUSC)



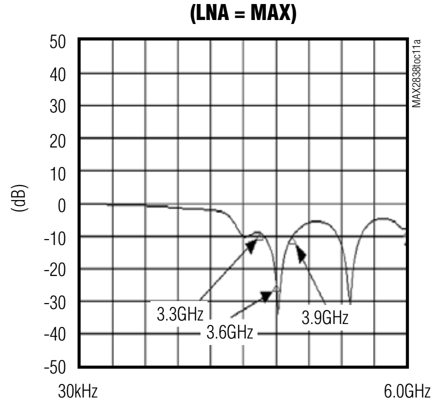
Rx EMISSION SPECTRUM, LNA INPUT (Tx OFF, LNA = MAX)



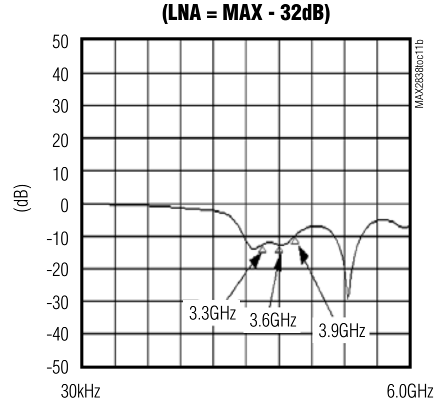
Rx INPUT DIFFERENTIAL IMPEDANCE vs. FREQUENCY



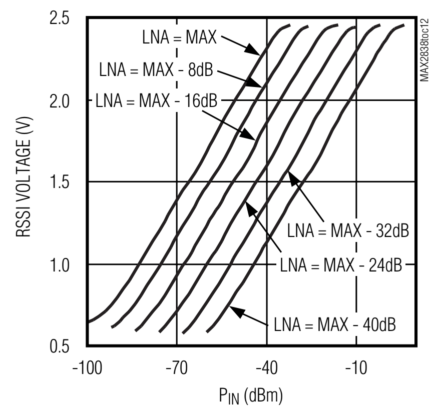
Rx INPUT RETURN LOSS vs. FREQUENCY (LNA = MAX)



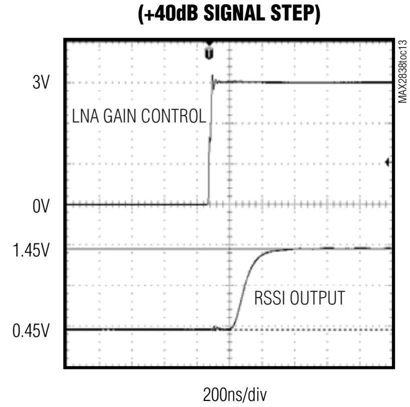
Rx INPUT RETURN LOSS vs. FREQUENCY (LNA = MAX - 32dB)



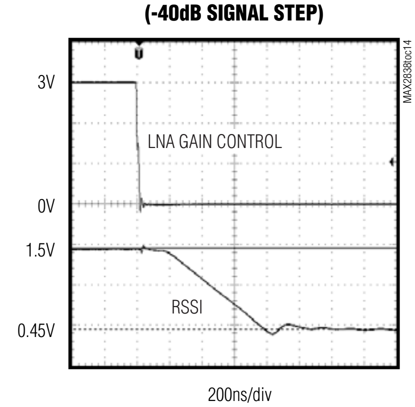
RSSI VOLTAGE vs. INPUT POWER



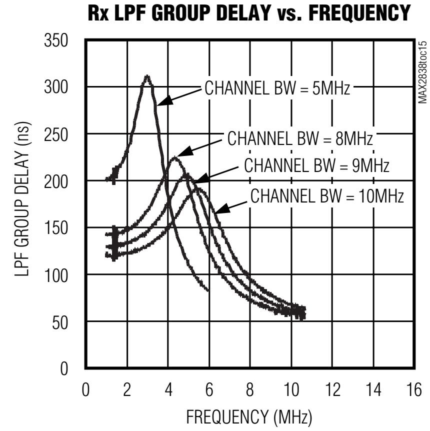
Rx RSSI STEP RESPONSE (+40dB SIGNAL STEP)



Rx RSSI STEP RESPONSE (-40dB SIGNAL STEP)



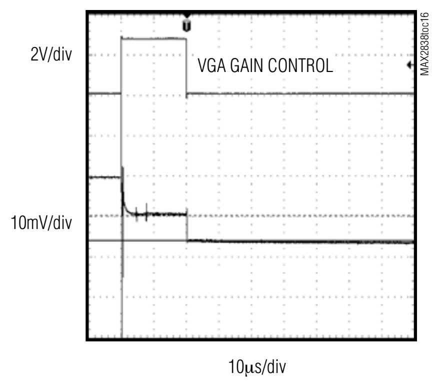
Rx LPF GROUP DELAY vs. FREQUENCY



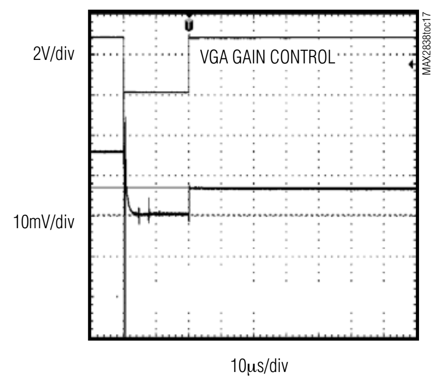
Typical Operating Characteristics (continued)

(V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, RXHP = SCLK = DIN = low, RF BW = 7MHz, using the MAX2838 Evaluation Kit.)

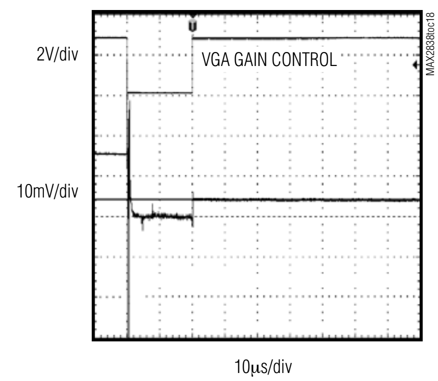
Rx DC OFFSET SETTLING RESPONSE (+8dB BB VGA GAIN STEP)



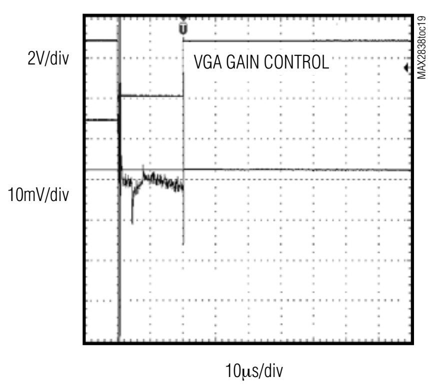
Rx DC OFFSET SETTLING RESPONSE (-8dB BB VGA GAIN STEP)



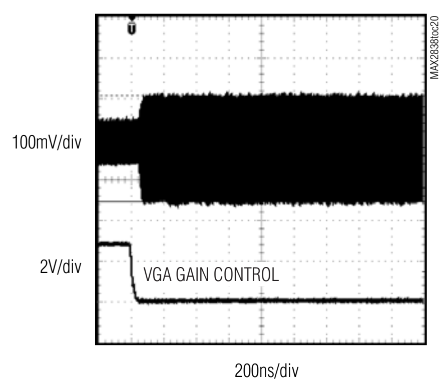
Rx DC OFFSET SETTLING RESPONSE (-16dB BB VGA GAIN STEP)



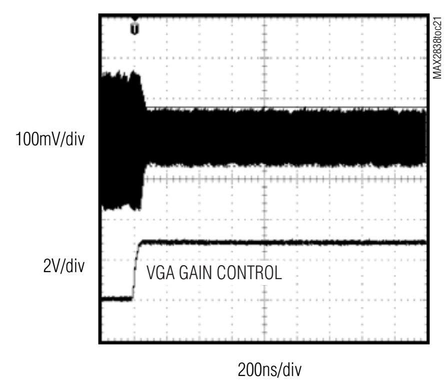
Rx DC OFFSET SETTLING RESPONSE (-32dB BB VGA GAIN STEP)



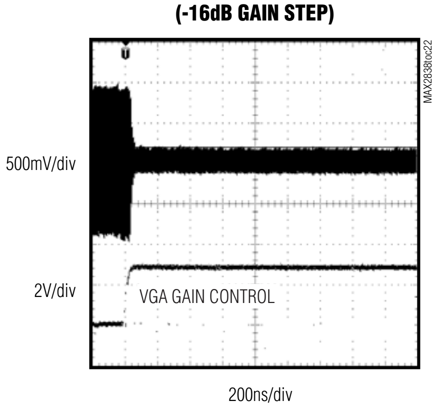
Rx BBVGA SETTLING RESPONSE (+8dB GAIN STEP)



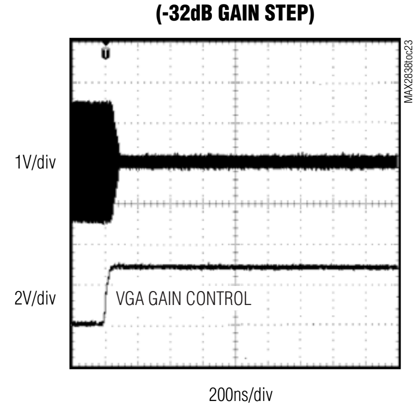
Rx BBVGA SETTLING RESPONSE (-8dB BB VGA GAIN STEP)



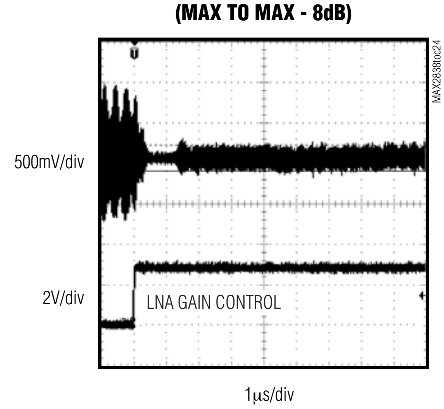
Rx BBVGA SETTLING RESPONSE (-16dB GAIN STEP)



Rx BBVGA SETTLING RESPONSE (-32dB GAIN STEP)



Rx LNA SETTLING RESPONSE (MAX TO MAX - 8dB)

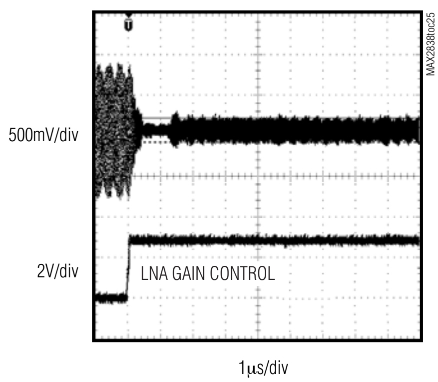


3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

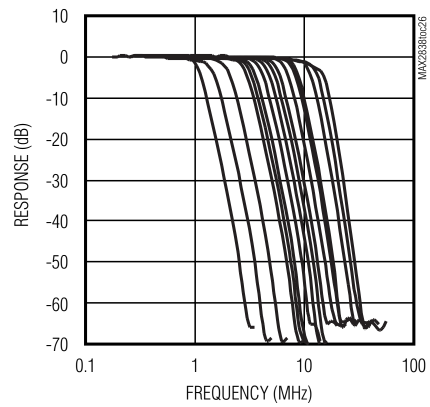
Typical Operating Characteristics (continued)

(V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, RXHP = SCLK = DIN = low, RF BW = 7MHz, using the MAX2838 Evaluation Kit.)

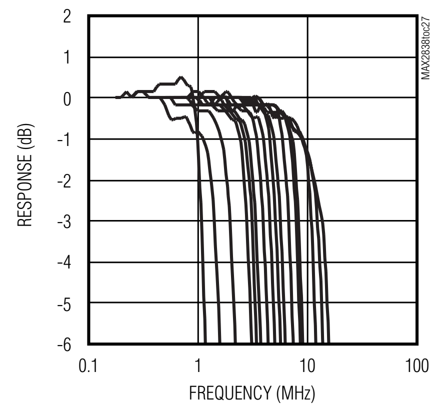
Rx LNA SETTLING RESPONSE (MAX TO MAX - 16dB)



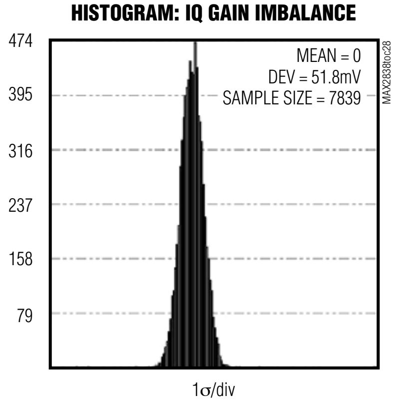
Rx BB FREQUENCY RESPONSE



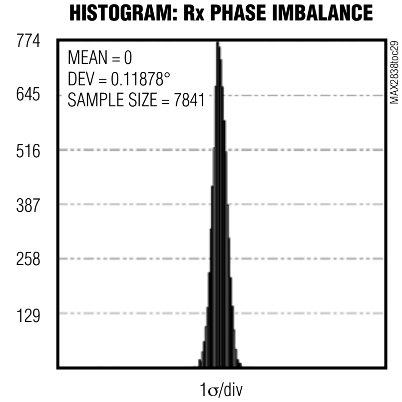
Rx BB FREQUENCY RESPONSE



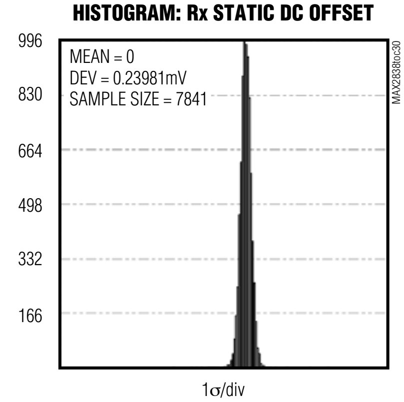
HISTOGRAM: IQ GAIN IMBALANCE



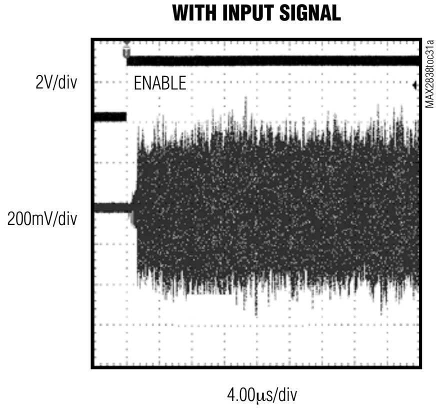
HISTOGRAM: Rx PHASE IMBALANCE



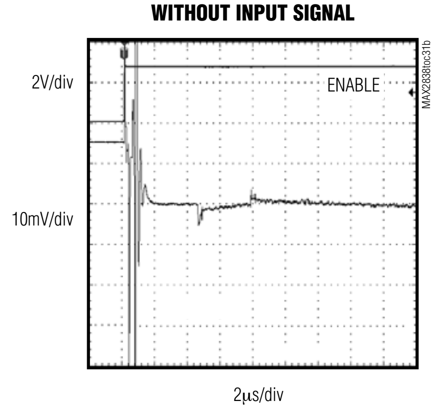
HISTOGRAM: Rx STATIC DC OFFSET



POWER-ON DC OFFSET CANCELLATION WITH INPUT SIGNAL

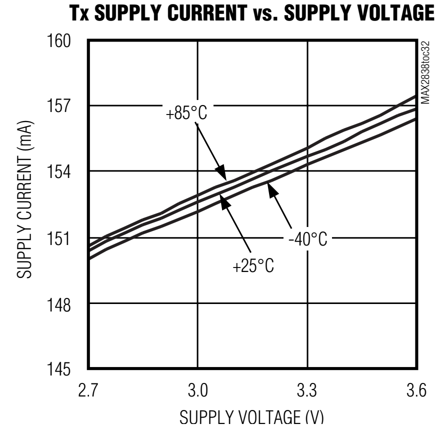


POWER-ON DC OFFSET CANCELLATION WITHOUT INPUT SIGNAL



TRANSMITTER

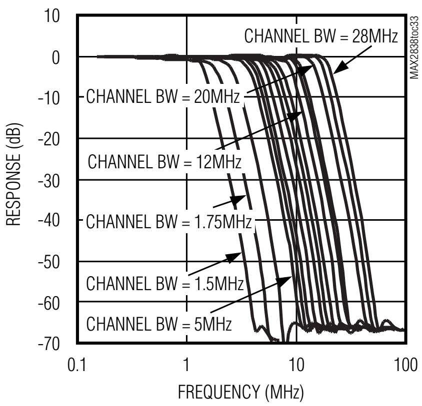
Tx SUPPLY CURRENT vs. SUPPLY VOLTAGE



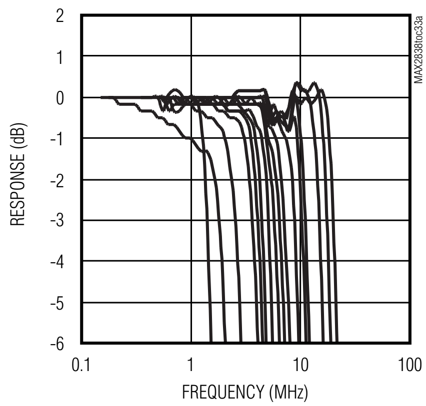
Typical Operating Characteristics (continued)

(V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, RXHP = SCLK = DIN = low, RF BW = 7MHz, using the MAX2838 Evaluation Kit.)

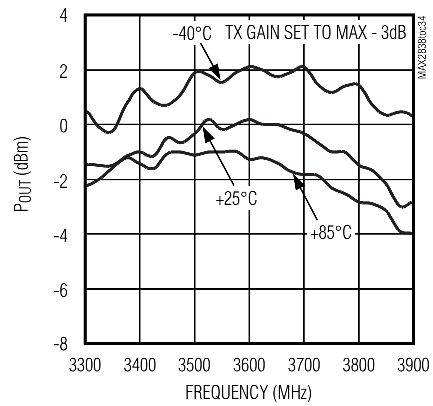
Tx BASEBAND FREQUENCY RESPONSE



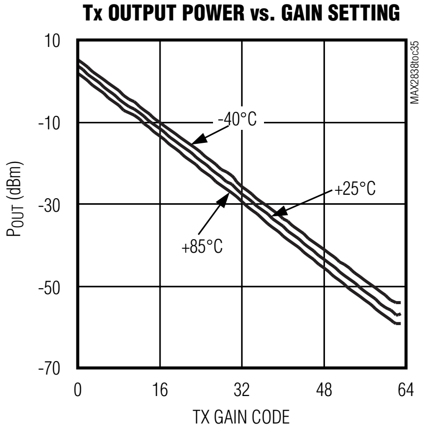
Tx BASEBAND FREQUENCY RESPONSE



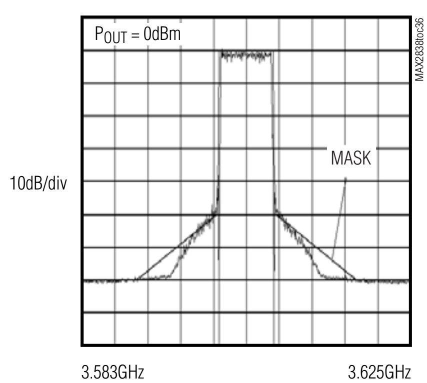
Tx OUTPUT POWER vs. FREQUENCY



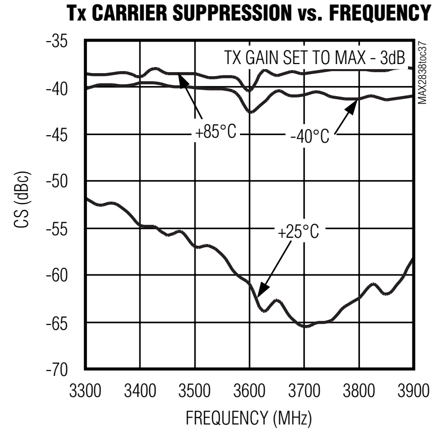
Tx OUTPUT POWER vs. GAIN SETTING



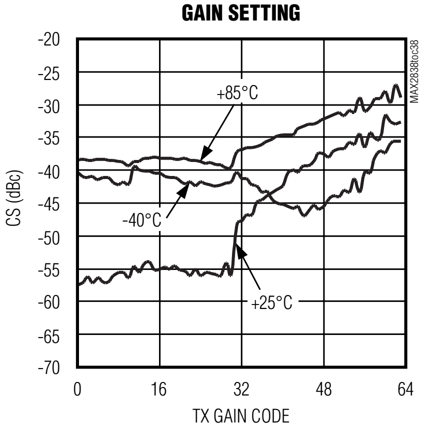
Tx OUTPUT SPECTRUM



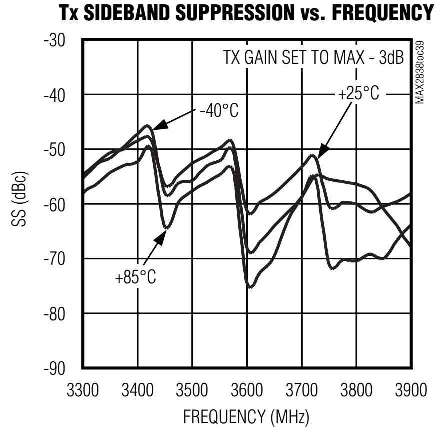
Tx CARRIER SUPPRESSION vs. FREQUENCY



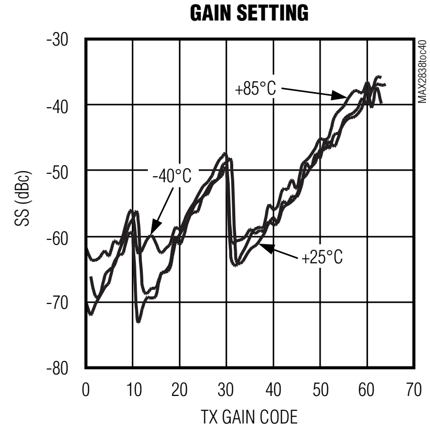
Tx CARRIER SUPPRESSION vs. GAIN SETTING



Tx SIDEBAND SUPPRESSION vs. FREQUENCY



Tx SIDEBAND SUPPRESSION vs. GAIN SETTING

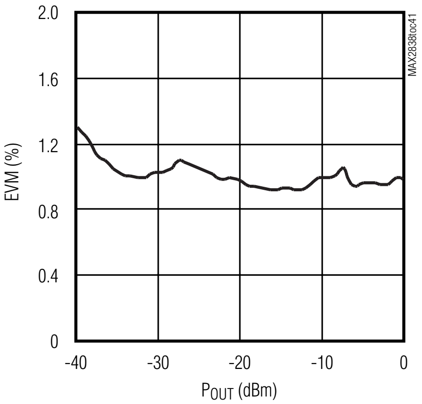


3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

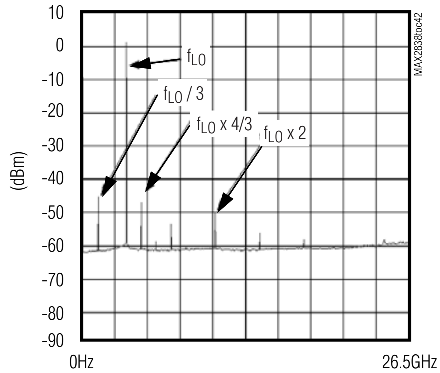
Typical Operating Characteristics (continued)

(V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, RXHP = SCLK = DIN = low, RF BW = 7MHz, using the MAX2838 Evaluation Kit.)

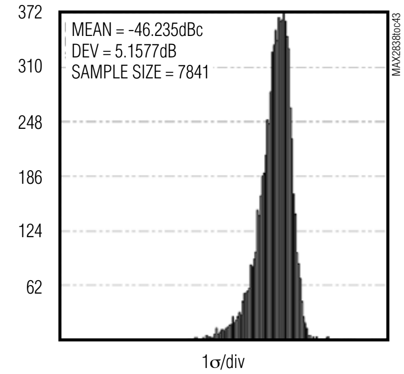
EVM vs. Tx OUTPUT POWER (64 QAM FUSC, 10MHz CHANNEL BANDWIDTH)



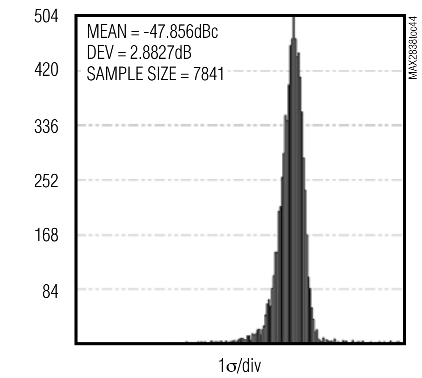
Tx OUTPUT EMISSION SPECTRUM



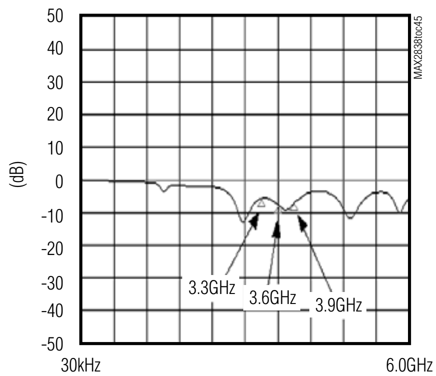
HISTOGRAM: Tx LO LEAKAGE



HISTOGRAM: Tx SIDEBAND SUPPRESSION

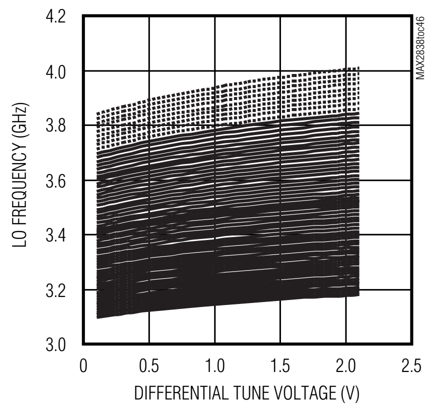


Tx OUTPUT RETURN LOSS vs. FREQUENCY

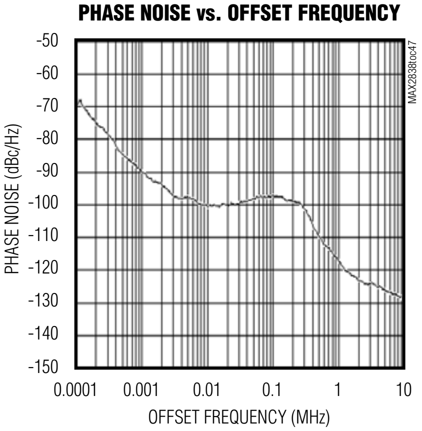


SYNTHESIZER

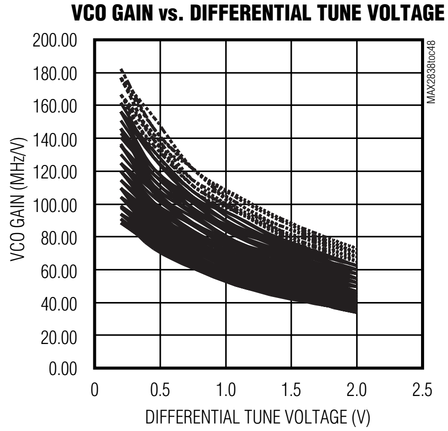
LO FREQUENCY vs. DIFFERENTIAL TUNE VOLTAGE



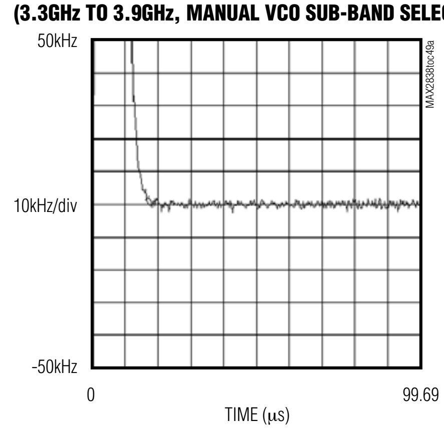
PHASE NOISE vs. OFFSET FREQUENCY



VCO GAIN vs. DIFFERENTIAL TUNE VOLTAGE



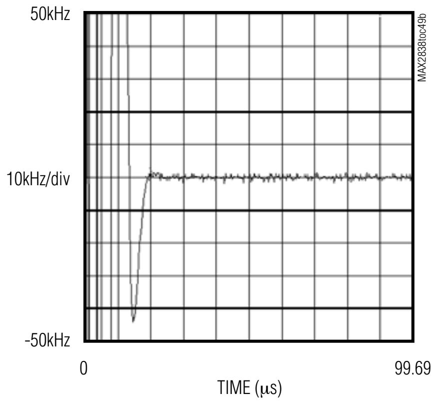
CHANNEL-SWITCHING FREQUENCY SETTLING (3.3GHz TO 3.9GHz, MANUAL VCO SUB-BAND SELECTION)



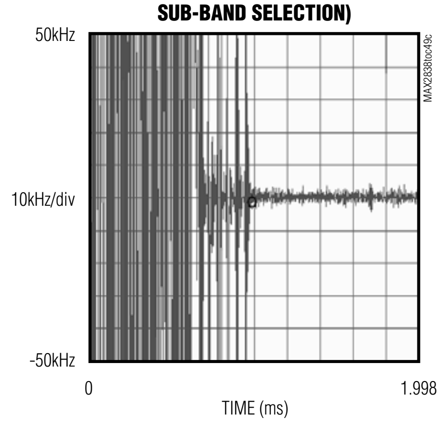
Typical Operating Characteristics (continued)

(V_{CC} = 2.8V, T_A = +25°C, f_{LO} = 3.6GHz, f_{REF} = 40MHz, $\overline{CS}$ = high, RXHP = SCLK = DIN = low, RF BW = 7MHz, using the MAX2838 Evaluation Kit.)

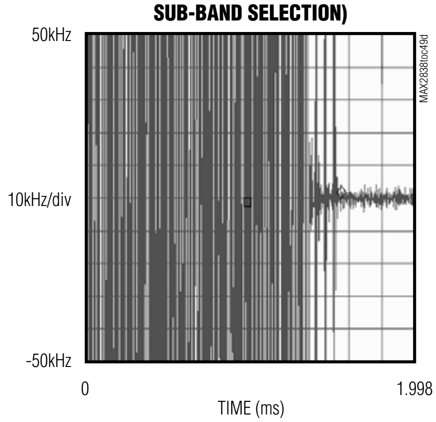
CHANNEL-SWITCHING FREQUENCY SETTLING (3.9GHz TO 3.3GHz, MANUAL VCO SUB-BAND SELECTION)



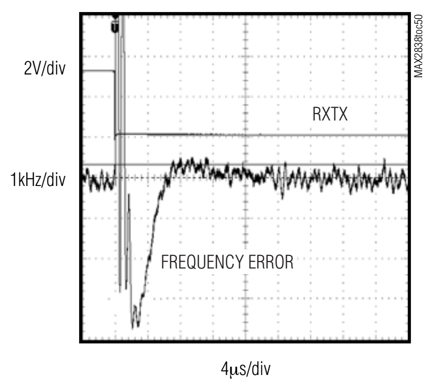
CHANNEL-SWITCHING FREQUENCY SETTLING (3.9GHz TO 3.3GHz, AUTOMATIC VCO SUB-BAND SELECTION)



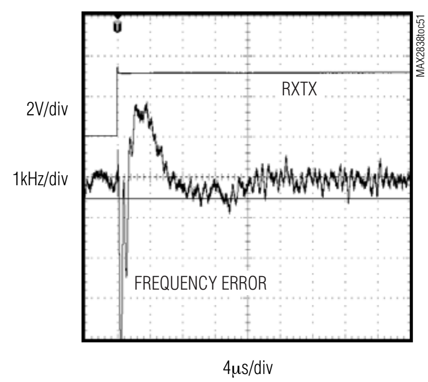
CHANNEL-SWITCHING FREQUENCY SETTLING (3.3GHz TO 3.9GHz, AUTOMATIC VCO SUB-BAND SELECTION)



Rx-TO-Tx TURNAROUND FREQUENCY GLITCH SETTLING

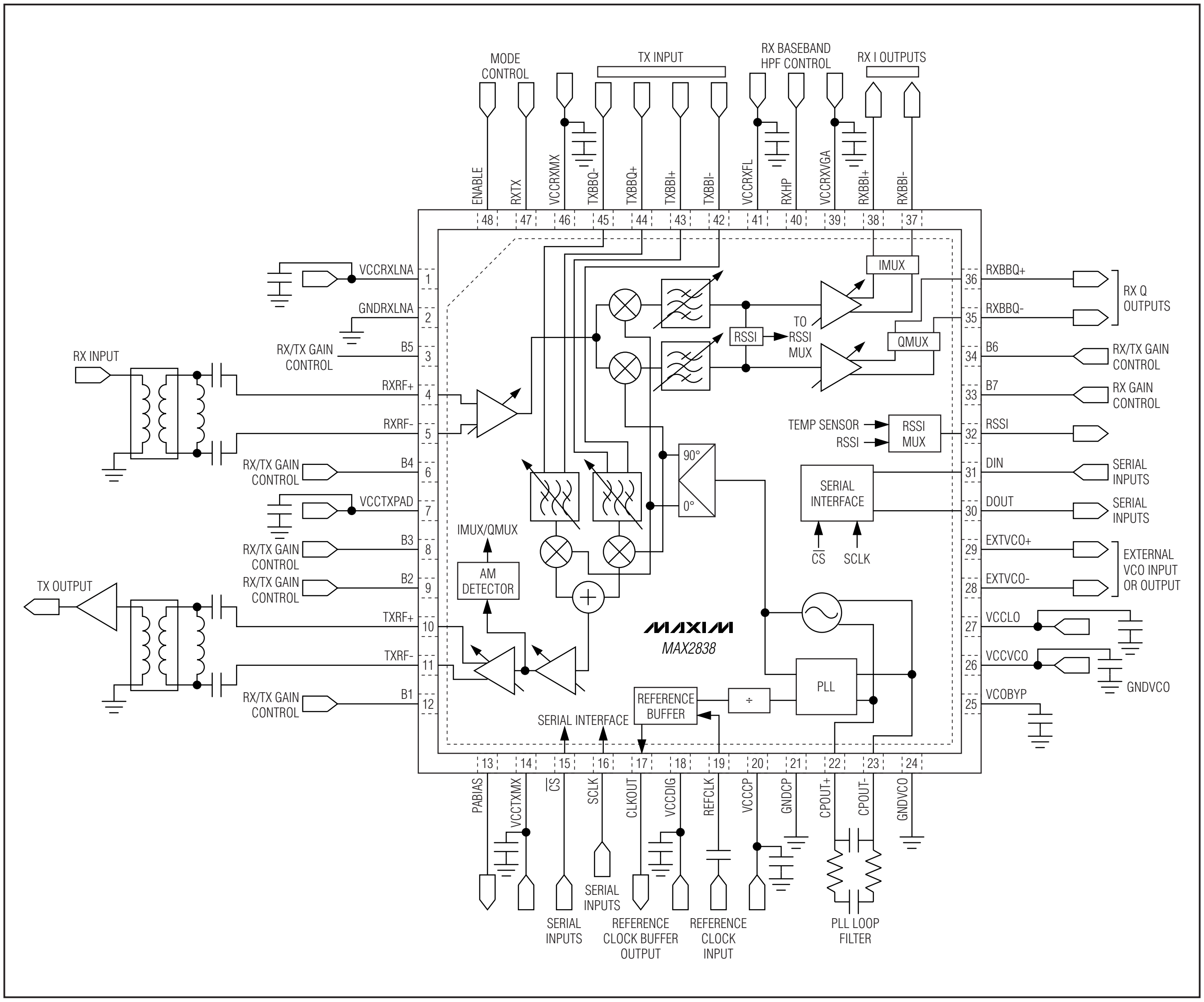


Tx-TO-Rx TURNAROUND FREQUENCY GLITCH SETTLING



3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

Typical Operating Circuit



Pin Description

PIN	NAME	FUNCTION
1	VCCRXLNA	LNA Supply Voltage. Bypass with a capacitor as close as possible to the pin.
2	GNDRXLNA	LNA Ground
3	B5	Receiver and Transmitter Gain-Control Logic Input Bit 5
4	RXRF+	LNA Differential Inputs. Inputs are internally DC-coupled. Two external series capacitors and one shunt inductor match the inputs to 100Ω differential.
5	RXRF-	
6	B4	Receiver and Transmitter Gain-Control Logic Input Bit 4
7	VCCTXPAD	Supply Voltage for Power-Amplifier Driver. Bypass with a capacitor as close as possible to the pin.
8	B3	Receiver and Transmitter Gain-Control Logic Input Bit 3
9	B2	Receiver and Transmitter Gain-Control Logic Input Bit 2
10	TXRF+	Power-Amplifier Driver Differential Output. Outputs are internally DC-coupled. Two external series capacitors and one shunt inductor match the outputs to 100Ω differential.
11	TXRF-	
12	B1	Receiver and Transmitter Gain-Control Logic Input Bit 1
13	PABIAS	Transmit PA Bias DAC Output
14	VCCTXMX	Transmitter Upconverter Supply Voltage. Bypass with a capacitor as close as possible to the pin.
15	$\overline{CS}$	Chip-Select Logic Input of 4-Wire Serial Interface (See Figure 1)
16	SCLK	Serial-Clock Logic Input of 4-Wire Serial Interface (See Figure 1)
17	CLKOUT	Reference Clock Divided Output
18	VCCDIG	Digital Circuit Supply Voltage. Bypass with a capacitor as close as possible to the pin.
19	REFCLK	Reference Clock Input
20	VCCCP	PLL Charge-Pump Supply Voltage. Bypass with a capacitor as close as possible to the pin.
21	GNDCP	Charge-Pump Circuit Ground
22	CPOUT+	Differential Charge-Pump Output. Connect the frequency synthesizer's loop filter between CPOUT+ and CPOUT- (see the *Typical Operating Circuit*).
23	CPOUT-	
24	GNDVCO	VCO Ground
25	VCOBYP	On-Chip VCO Regulator Output Bypass. Bypass with a 1μF capacitor to GND. Do not connect other circuitry to this point.
26	VCCVCO	VCO Supply Voltage. Bypass with a capacitor as close as possible to the pin.
27	VCCLO	LO Generation Supply Voltage. Bypass with a capacitor as close as possible to the pin.
28	EXTVCO-	External VCO Differential Input or Output. Input for slave configuration and output for master configuration. Leave unconnected for single configuration.
29	EXTVCO+	
30	DOUT	Data Logic Output of 4-Wire Serial Interface (See Figure 1)
31	DIN	Data Logic Input of 4-Wire Serial Interface (See Figure 1)
32	RSSI	RSSI or Temperature Sensor Multiplexed Analog Output
33	B7	Receiver Gain-Control Logic Input Bit 7
34	B6	Receiver and Transmitter Gain-Control Logic Input Bit 6
35	RXBBQ-	Receiver Baseband Q-Channel Differential Outputs. In Tx calibration mode, these pins are the LO leakage and sideband detector outputs.
36	RXBBQ+	
37	RXBBI-	Receiver Baseband I-Channel Differential Outputs. In Tx calibration mode, these pins are the LO leakage and sideband detector outputs.
38	RXBBI+	
39	VCCRXVGA	Receiver VGA Supply Voltage. Bypass with a capacitor as close as possible to the pin.

Pin Description (continued)

PIN	NAME	FUNCTION
40	RXHP	Receiver Baseband AC-Coupling Highpass Corner Frequency Control Logic Input. Connect to ground if not being used.
41	VCCRXFL	Receiver Baseband Filter Supply Voltage. Bypass with a capacitor as close as possible to the pin.
42	TXBBI-	Transmitter Baseband I-Channel Differential Inputs
43	TXBBI+	
44	TXBBQ+	Transmitter Baseband Q-Channel Differential Inputs
45	TXBBQ-	
46	VCCRXMX	Receiver Downconverters Supply Voltage. Bypass with a capacitor as close as possible to the pin.
47	RXTX	Mode Control Logic Input. See Table 1 for operating modes.
48	ENABLE	Mode Control Logic Input. See Table 1 for operating modes.
—	EP	Exposed Paddle. Connect to the ground plane with multiple vias for proper operation and heat dissipation. Do not share with any other pin grounds and bypass capacitors' ground.

Table 1. Operating Mode for MIMO Master and Single Configuration (Note 5)

	MODE CONTROL LOGIC INPUTS			CIRCUIT BLOCK STATES				
MODE	SPI REG 16, D1:D0 (Note 6)	ENABLE PIN	RXTX PIN	Rx PATH	Tx PATH	PLL, VCO	CLOCK OUT	CALI-BRATION SECTIONS ON
SHUTDOWN	xx	0	0	Off	Off	Off	Off	None
STANDBY (Note 7)	01	0	1	Off	Off	On	On	None
CLOCK OUT	00 (Note 11)	0	1	Off	Off	Off	On	None
Rx	01	1	1	On	Off (Note 8)	On	On	None
Tx	01	1	0	Off	On	On	On	None
Tx CALIBRATION (Note 9)	11	1	0	Off	On (except PA driver)	On	On	AM detector + RX I,Q buffers
Rx CALIBRATION (Note 10)	11	1	1	On (except LNA)	On (except PA driver)	On	On	Loopback

Note 5: Set SPI Reg 24 D1:D0 = "00" for single-transceiver mode of operation. Set SPI Reg 16 D4:D3 = "11," Reg 24 D8 = "1," Reg 24 D1:D0 = "01" for MIMO master configuration.
Note 6: Unused states of SPI Reg 16, D1:D0 above are not tested, and therefore, should not be used.
Note 7: Parts of transceiver may be selectively enabled.
Note 8: PA bias DAC may be kept active in these non-transmit mode(s) by SPI programming.
Note 9: Set SPI Reg 5 D5 = "1" to mux AM detector output to RXBB pins.
Note 10: Set SPI Reg 26 D3 = "1."
Note 11: CLKOUT signal is active independent of the states of SPI Reg 16, D1:D0, and is only dependent on the states of ENABLE and RXTX pins. However, to ensure that the rest of the chip is off when the CLKOUT is active in the clock-out mode, set SPI Reg 16, D1:D0 to "00" as shown above.

Table 2. Operating Mode for MIMO Slave Configuration (Note 12)

	MODE CONTROL LOGIC INPUTS			CIRCUIT BLOCK STATES				
MODE	**SPI REG 16, D1:D0 (Note 4)**	**ENABLE PIN**	**RXTX PIN**	**Rx PATH**	**Tx PATH**	**PLL, VCO**	**CLOCK OUT**	**CALIBRATION SECTIONS ON**
SHUTDOWN	xx	0	0	Off	Off	Off	Off	None
STANDBY (Note 7)	01	0	1	Off	Off	Off	On	None
CLOCK OUT	00 (Note 11)	0	1	Off	Off	Off	On	None
Rx	01	1	1	On	Off (Note 8)	Off	On	None
Tx	01	1	0	Off	On	Off	On	None
Tx CALIBRATION (Note 9)	11	1	0	Off	On (except PA driver)	Off	On	AM detector + RX I,Q buffers
Rx CALIBRATION (Note 10)	11	1	1	On (except LNA)	On (except PA driver)	Off	On	Loop-back

Note 12: Set SPI Reg 16 D4:3 = "00," Reg 24 D8 = "0," Reg 24 D1:0 = "10" to select the MIMO slave configuration.

Detailed Description

Configurations

The MAX2838 can be configured in a) single mode, for non-MIMO or SISO applications, b) MIMO master mode, and c) MIMO slave mode. Options b) and c) are for MIMO applications where a coherent LO is required for all transmitters and all receivers.

Modes of Operation

The modes of operation for the MAX2838 are clock-out, shutdown, standby, Tx, Rx, Tx calibration, and Rx calibration. See Table 1 for a summary of the modes of operation. The logic input pins—RXTX (pin 47) and ENABLE (pin 48)—control the various modes.

Shutdown Mode (Complete IC Power-Down)

All circuit blocks are powered down, except the 4-wire serial bus and its internal programmable registers. Current drain is the minimum possible with the supply voltages applied. If the digital supply voltage is applied at the VCCDIG pin, the registers can be loaded.

Standby Mode

PLL, VCO, and LO generation blocks are ON, so that Tx or Rx modes can be quickly enabled from this mode. These and other blocks may be selectively enabled in this mode.

Rx Mode

All Rx circuit blocks are powered on and active. Antenna signal is applied; RF is downconverted, filtered, and buffered at Rx BB I & Q outputs.

Tx Mode

All Tx circuit blocks are powered on. The external PA is powered on after a programmable delay.

Clock-Out Only

Only the clock-out signal is active on the CLKOUT pin. The clock output divider is also functional. The rest of the transceiver is powered down.

Rx Calibration

Part of the Rx and Tx circuit blocks except the LNA and PA driver are powered on and active. The transmitter IQ input signal is upconverted to RF and at the output of the Tx gain control (VGA). It is fed to the receiver at the input of the downconverter. Either or both of the two receiver channels can be connected to the transmitter and powered on. The I/Q lowpass filters are not present in the transmitter signal path (they are bypassed).

Tx Calibration

All Tx circuit blocks except the PA driver and external PA are powered on and active. The AM detector and receiver I/Q channel buffers are also on, along with multiplexers in receiver side to route this AM detector's signal to each I and Q differential lines.

3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

Programmable Registers and 4-Wire SPI-Interface

The MAX2838 includes 32 programmable 16-bit registers. The most significant bit (MSB) is the read/write selection bit. The next 5 bits are register addresses. The 10 least significant bits (LSBs) are register data. Register data is loaded through the 4-wire SPI/MICROWIRE™-compatible serial interface. Data at the DIN pin is shifted in MSB first and is framed by $\overline{CS}$. When $\overline{CS}$ is low, the clock is active, and input data is shifted at the rising edge of the clock. During the read mode, register data selected by address bits is shifted out to the DOUT pin at the falling edges of the clock. At $\overline{CS}$ rising edge, the 10-bit data bits are latched into the register selected by address bits. See Figure 1.

MICROWIRE is a trademark of National Semiconductor Corp.

Chip Information

PROCESS: BiCMOS

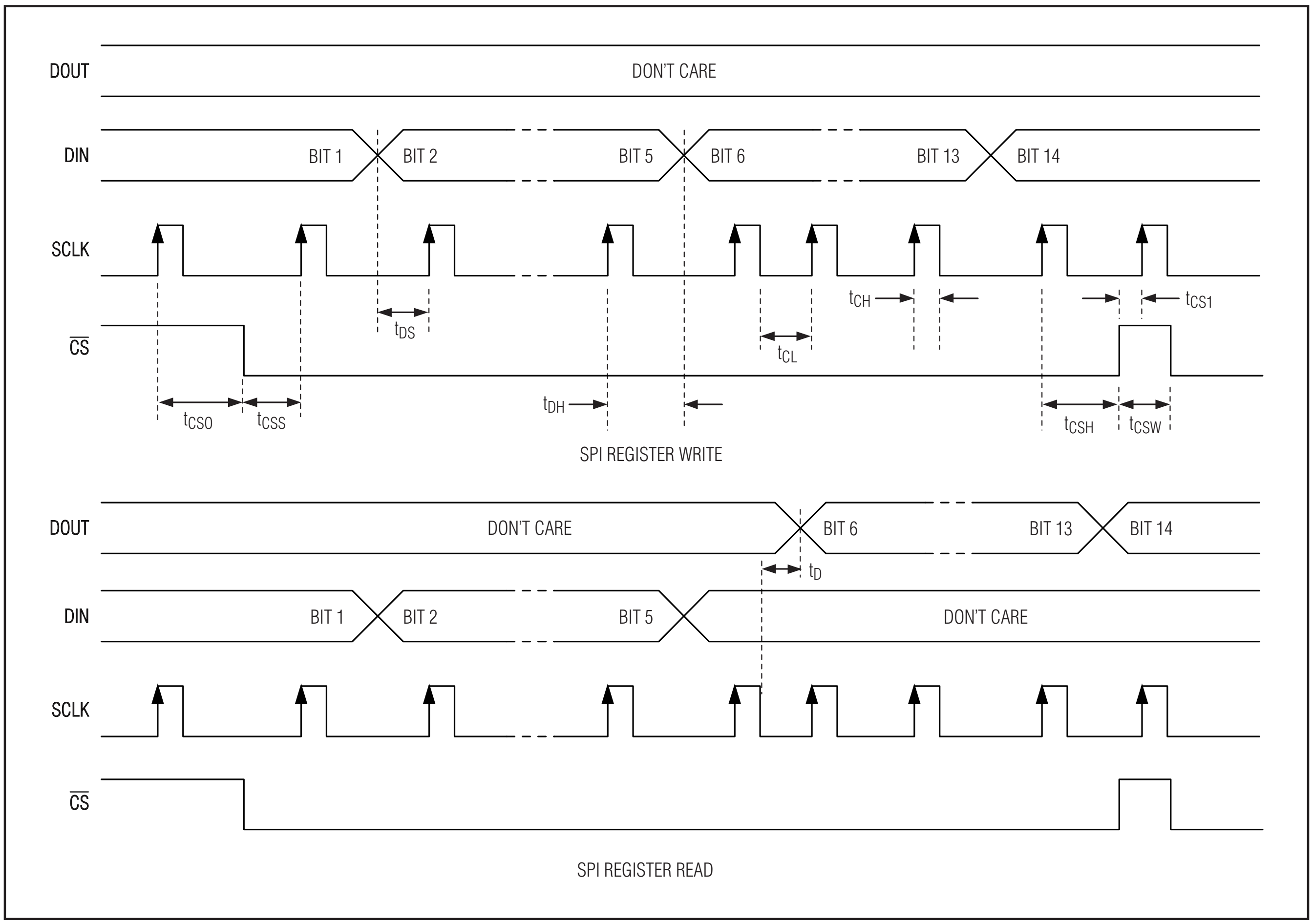


Figure 1. 4-Wire SPI Serial-Interface Timing Diagram

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
48 TQFN-EP	T4866+2	21-0141

3.3GHz to 3.9GHz Wireless Broadband RF Transceiver

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/07	Initial release	—
1	8/08	Removed CLKOUT frequency divide-by-1 ratio in *AC Electrical Characteristics—Frequency Synthesis* table	7